

Overview of results on charge
collection in ATLAS strip detectors

by

Vladimir Eremin

on behalf of CERN-ATLAS
SCTgroup

Ioffe Physico-Technical Institute
St. Petersburg
RUSSIA

CERN
RD 50 meeting, May 18-20.2003

Outline

1. Approaches
2. INTAS project
3. Physics of Current Injection Detectors (CID)
 - Electric field in sensitive region
 - I-V characteristics
 - Operational parameters
4. Experimental proof
 - structures of CIDs
 - preirradiation test
 - Irradiation
 - CIDs evaluation
5. Conclusions

Two ways of Si-detectors radiation hardness improvement

Material engineering

Si doped by:

- Oxygen
 - Oxy diffusion
 - Cz - silicon
- Defects
 - epy - silicon
 - pre-irradiated

Problems:

- "Technological" factor
- No improvement for n^0

Detector engineering

Regular

3D



- Increase of $V_{operational}$
- Temperature controlled effects:

- | | | |
|-----------------------|---|---|
| I
N
T
A
S | { | <ul style="list-style-type: none"> - Lazarus - Electric field manipulation - Space charge limited current in deep level rich Silicon |
|-----------------------|---|---|

electric field manipulation?

approach non sensitive for material
ties

simple physics

stable operational parameters

and low power consumption

d of INTAS project

ion by current injection in heavy
detectors

PTI NIM A 360 (1995) 458

u of I-V characteristics of heavy
detectors after space charge sign inversion

PTI NIM A 383 (1996) 528

ration at forward bias

ster, NIM A 395 (1997) 81, CERN RD 39
NIM A 399 (1997) 35, NIM A 440 (2000) 5

ed manipulation by current injection

TI, INFN IEEE Trans NS V.4, N3 (1999) 221

TI IEEE NSS meeting, proceedings (2000)

solid state physics

Electric field manipulation

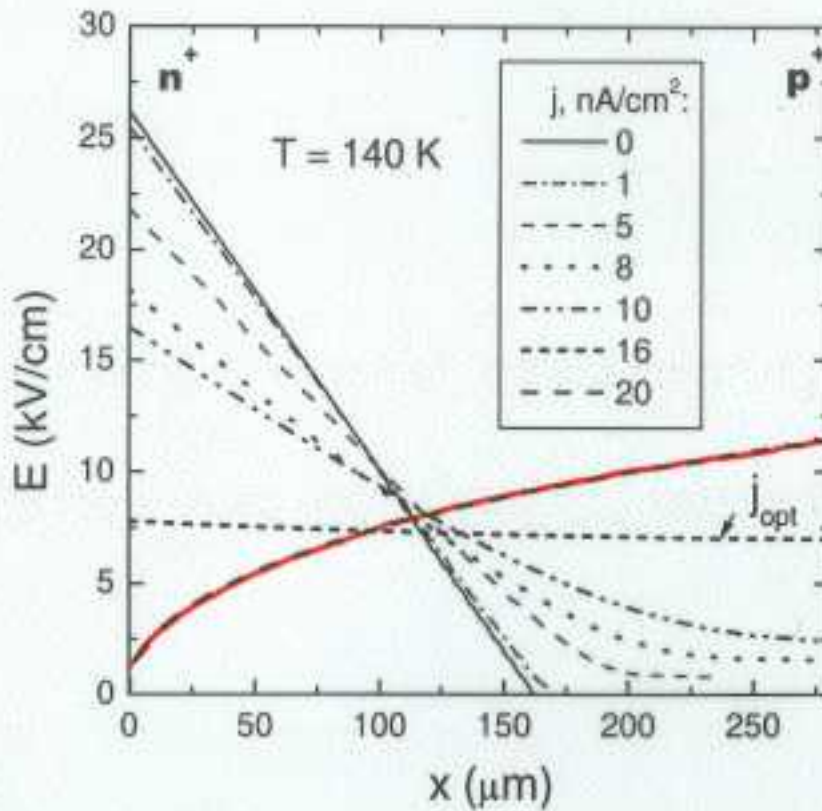
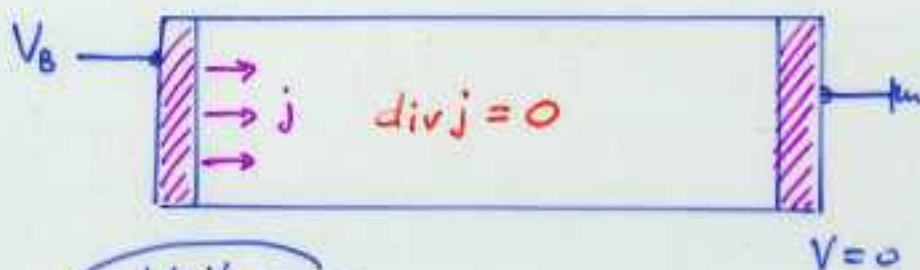


Fig. 5.1 Dependence of the electric field distribution on the hole injection current density in a Si detector irradiated by neutrons.
 $\Phi_n = 1.4 \cdot 10^{14} \text{ cm}^{-2}$; $V = 210 \text{ V}$.

IGEE-NSS meeting, 2000

Electric field distribution in CID

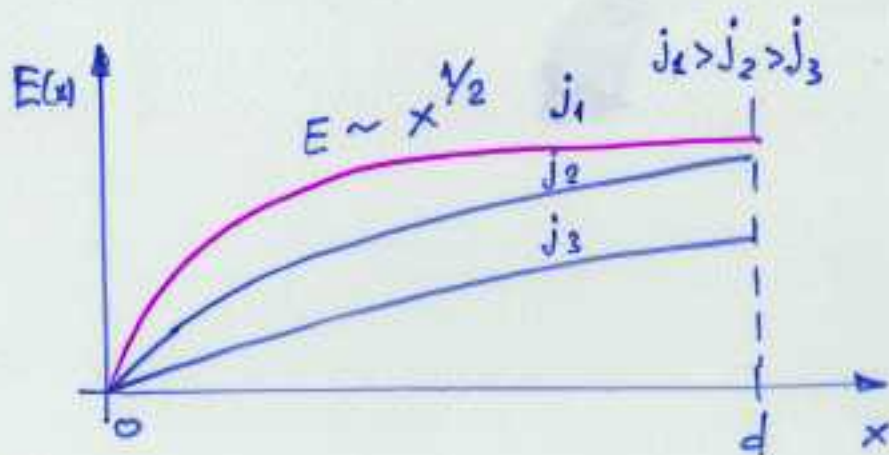
(DL free material)



$V = V_B$
 $E = E(0)$

$$\begin{cases} j = e \mu n E(x) \\ \frac{e}{e} \frac{dE}{dx} = n \end{cases} + \text{B.e.}$$

$$\underline{E(x) = \sqrt{\frac{2j}{e\mu}} x^{1/2} \quad \text{at } E(0) = 0}$$



$V = f(j)$

Electric field distribution in CID

(DL rich material)

$$\begin{cases} j = en\mu E \\ \frac{e}{e} \frac{dE}{dx} = n_t \end{cases}$$

B.C.: $E(0) = 0$

$$\frac{n}{n_t} = \phi \ll 1$$

$$n_t \propto N_{DL}$$

$$E(x) = \sqrt{2j} \cdot x^{1/2} = \sqrt{N_{DL}} \cdot x^{1/2}$$

I-V characteristics of CID

Space charge Limited current

- DL free material

$$E(x) = \sqrt{\frac{2j}{\epsilon \epsilon_m}} x^{1/2}$$

$\Downarrow$

$$j \sim \frac{\epsilon_m V^2}{d^3}$$

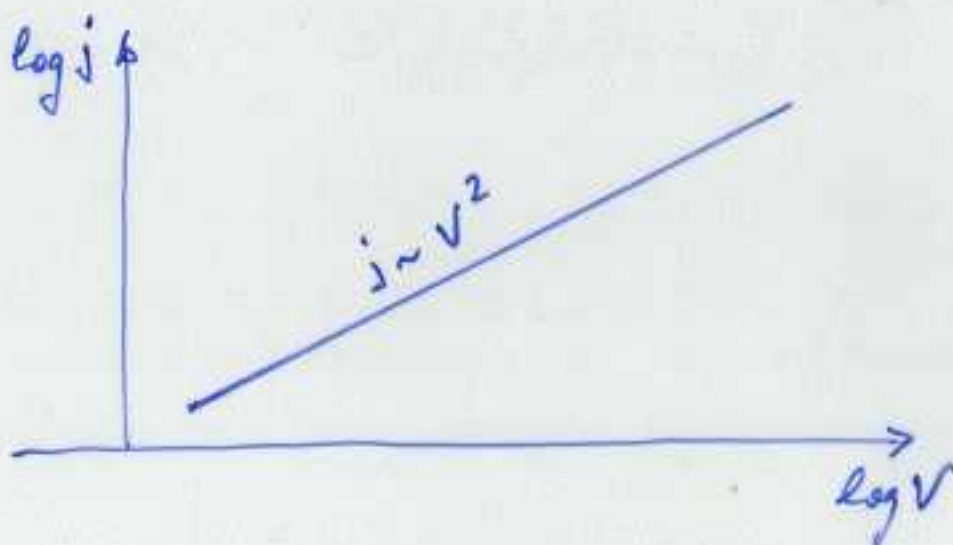
- DL rich material

$$E(x) = \sqrt{\frac{2j}{\epsilon \epsilon_m}} x^{1/2}$$

$$\epsilon \Rightarrow \frac{n}{n_t} \ll 1$$

$$j \sim \frac{\epsilon \epsilon_m V^2}{d^3}$$

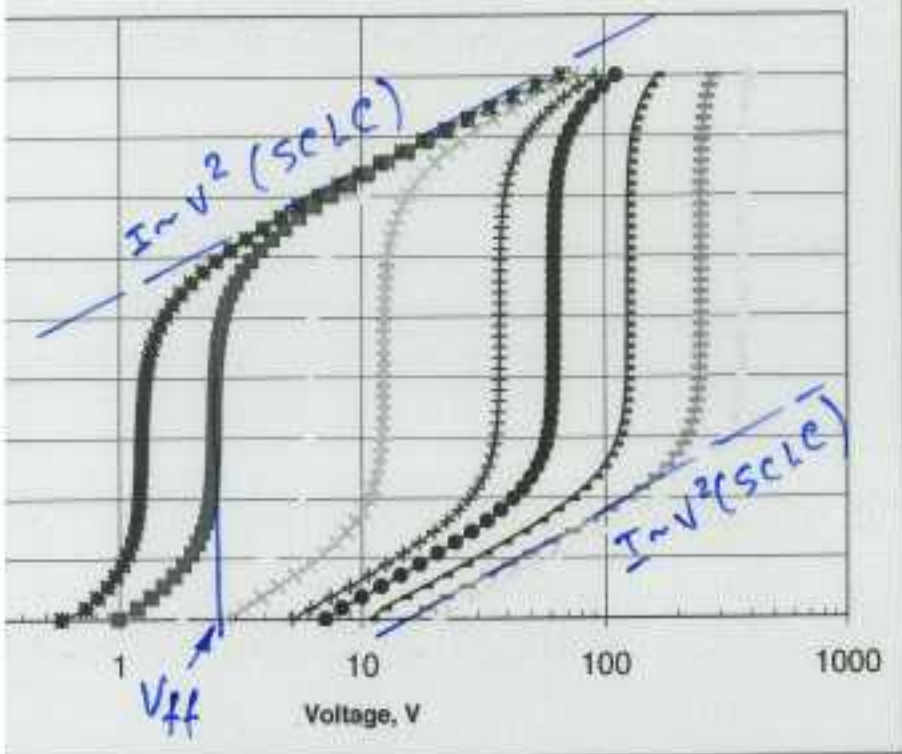
$$j_{free\ car} \gg j_{DL}!$$



I-V characteristics of CID

forward biased p⁺-n- Ω CID

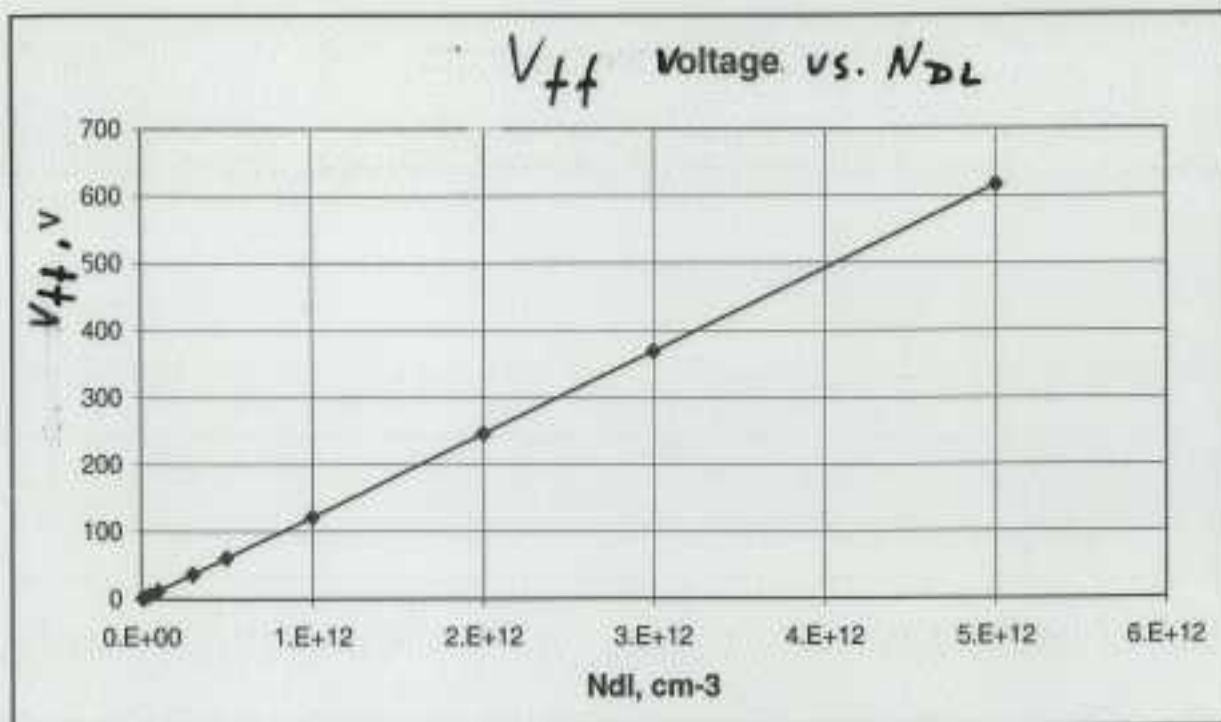
CID I-V at 180K, DL: Ev+0.51eV



voltage of DL full filling

parameters: $T=180K$, $E_v+0.51$, $d=400\mu m$

Ci-Oi		V-V		3		1	
0		1		0		1	
electrons	holes	electrons	holes	electrons	holes	electrons	holes
0.4		0.7		0.51	0.61	0.55	0.57
1.00E-15		1.00E-17		1.00E-15		5.00E-15	
1.00E-15		1.00E-15		1.00E-15		5.00E-15	

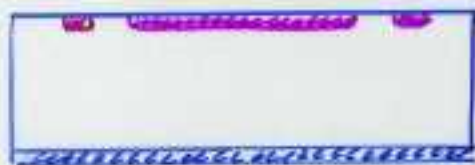


$$V_{ff} \approx \frac{e N_{DL}^* d^2}{\epsilon}$$

! V_{ff} - maximum operational bias of CID

N_{DL} - non occupied fraction of DL

Detector structures



p^+
 n
 n^+



p^+
 n
 p^+



n^+
 p
 p^+



p^+
 p
 p^+

Irradiation

Protons 24 GeV

Run #	$\Phi_p \text{ cm}^{-2}$
218	$6.8 \cdot 10^{10}$
214	$1.08 \cdot 10^{14}$
215	$3.2 \cdot 10^{14}$
216	$5.58 \cdot 10^{14}$
217	$8.63 \cdot 10^{14}$
213	$3.75 \cdot 10^{15}$

Beneficial annealing:

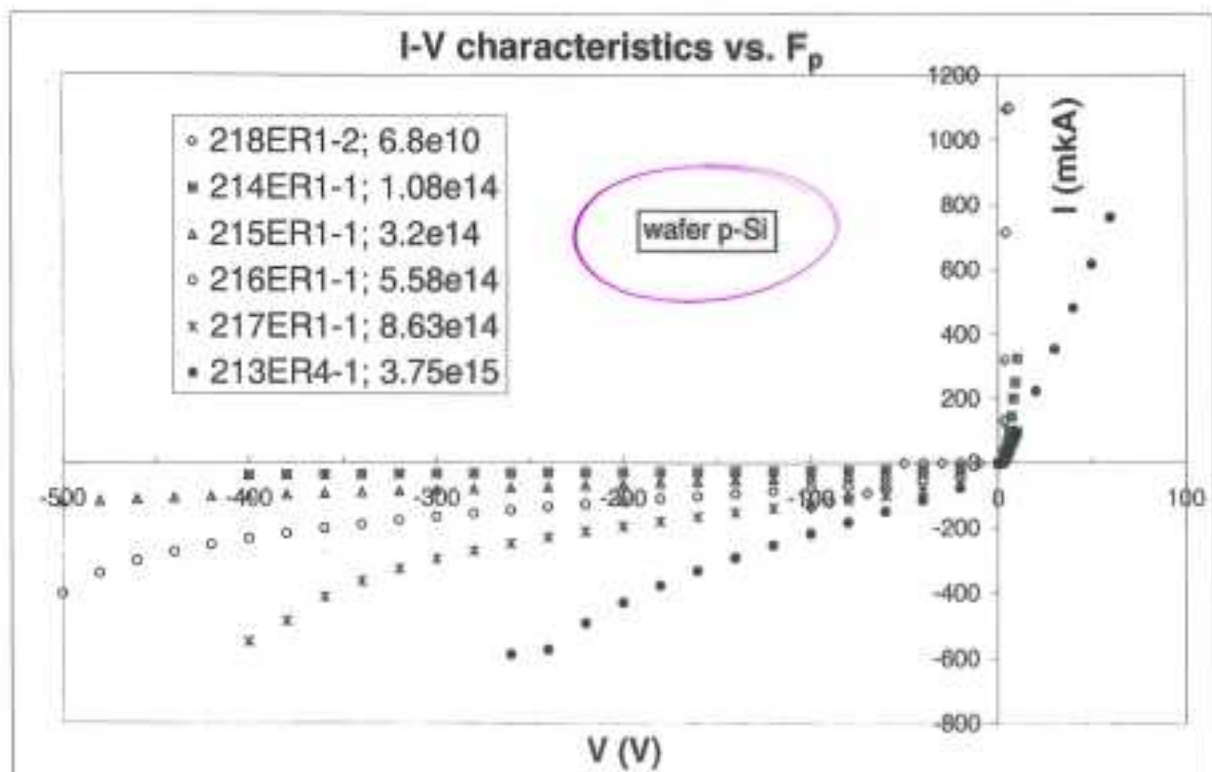
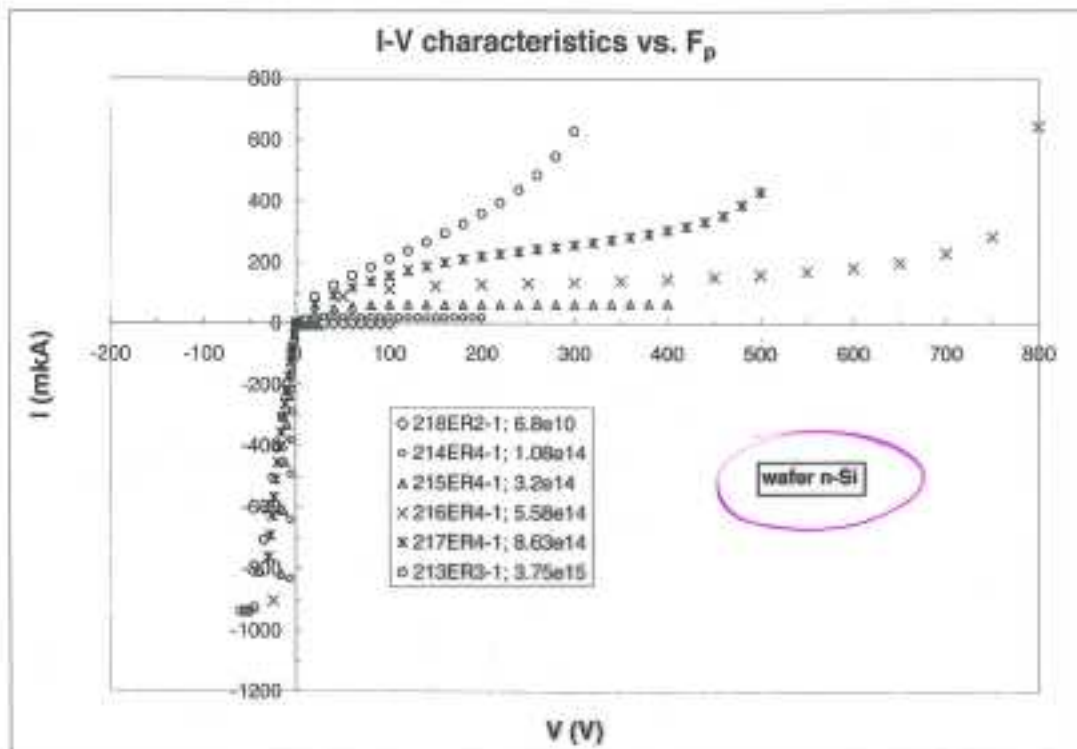
80° : 3 min

RT-evaluation

- C-V
- I-V

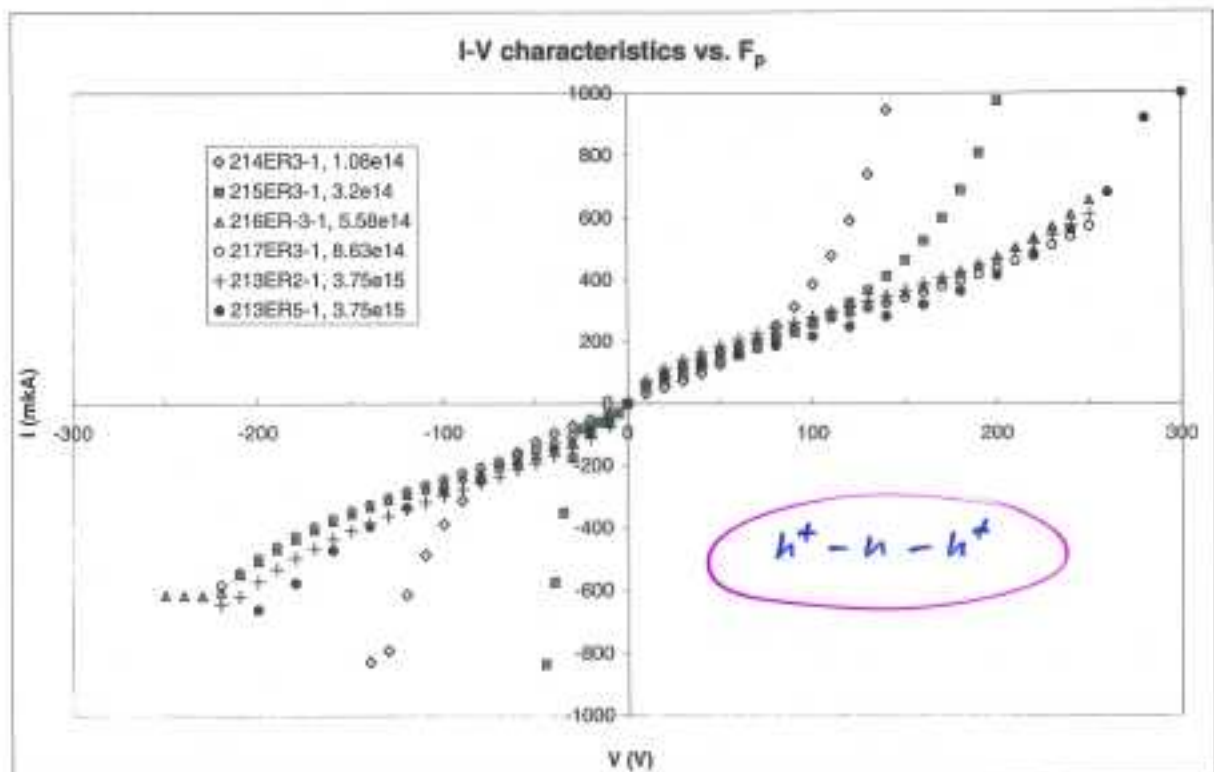
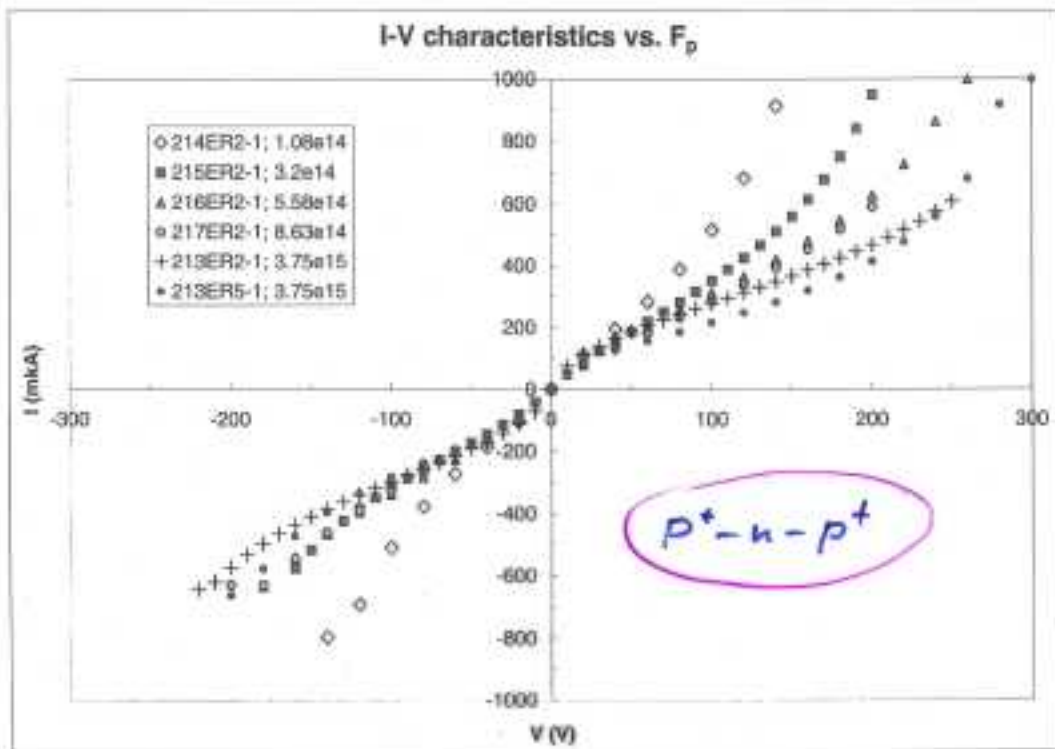
RT-I-V curves

- P-n junction detectors

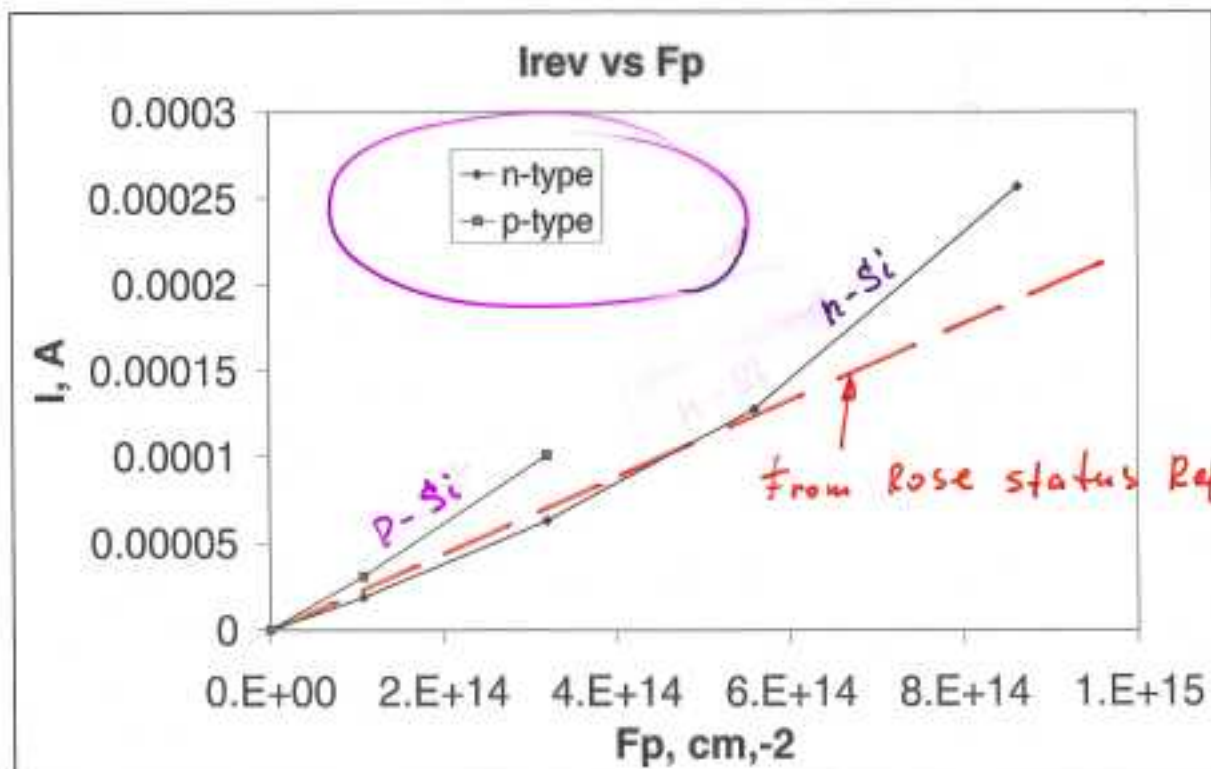
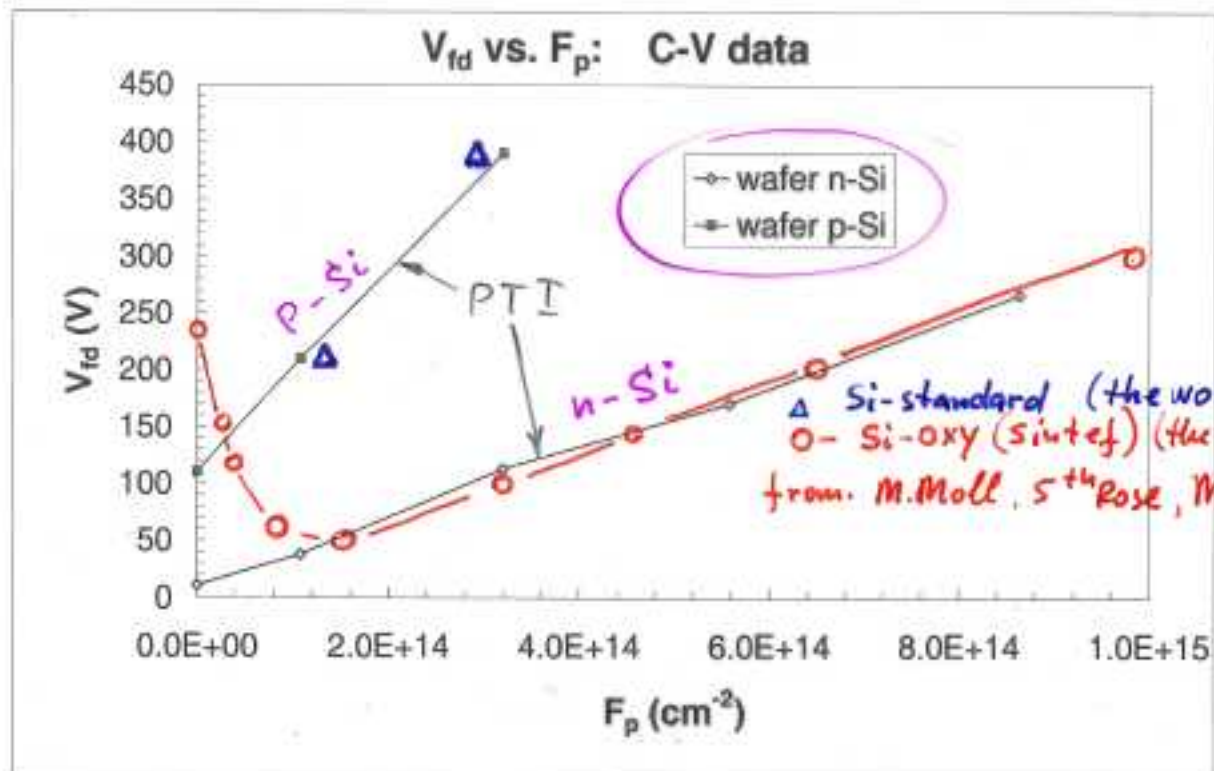


RT - I-V curves

Symmetric structures

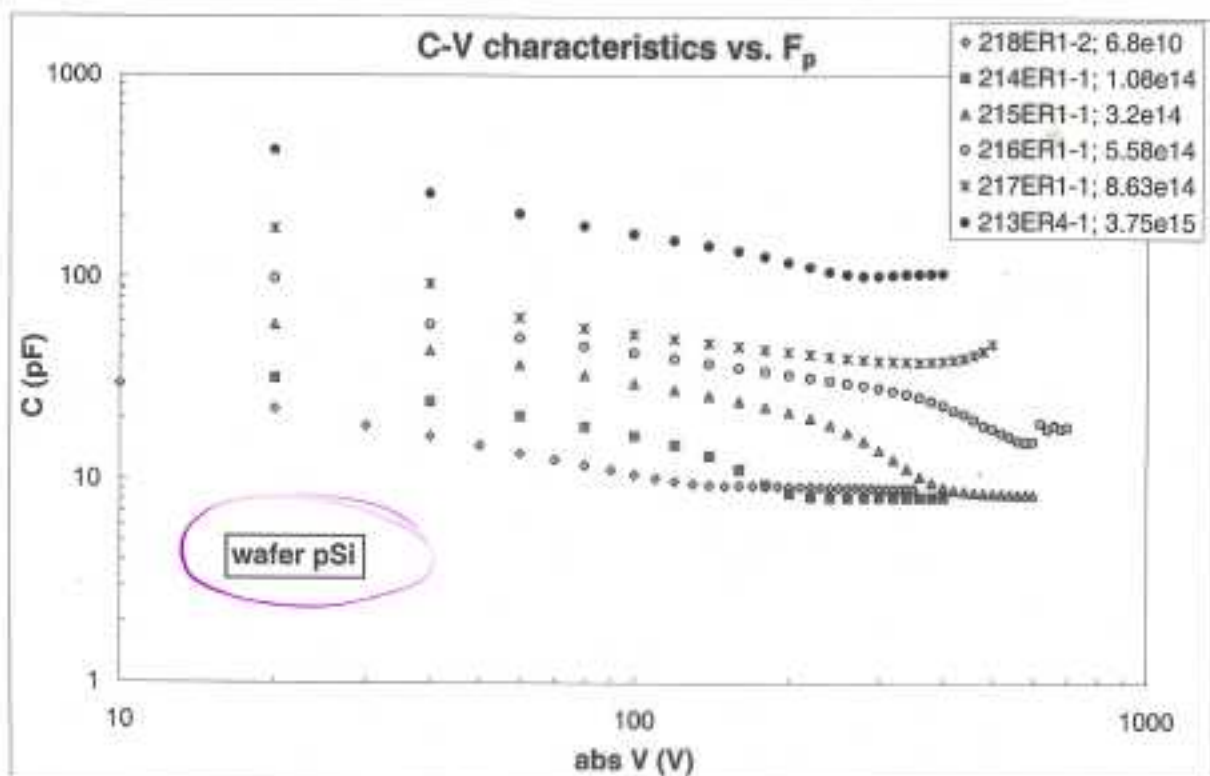
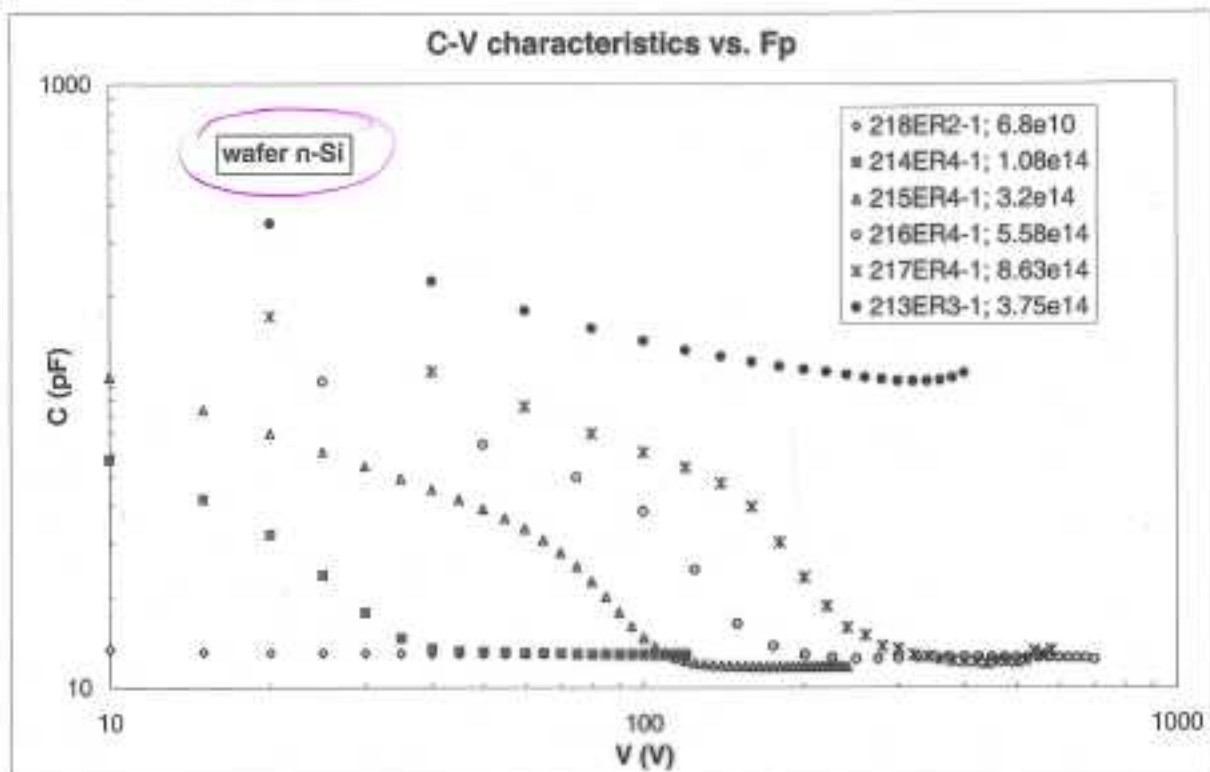


V_{fd} and I_r degradation with P_p



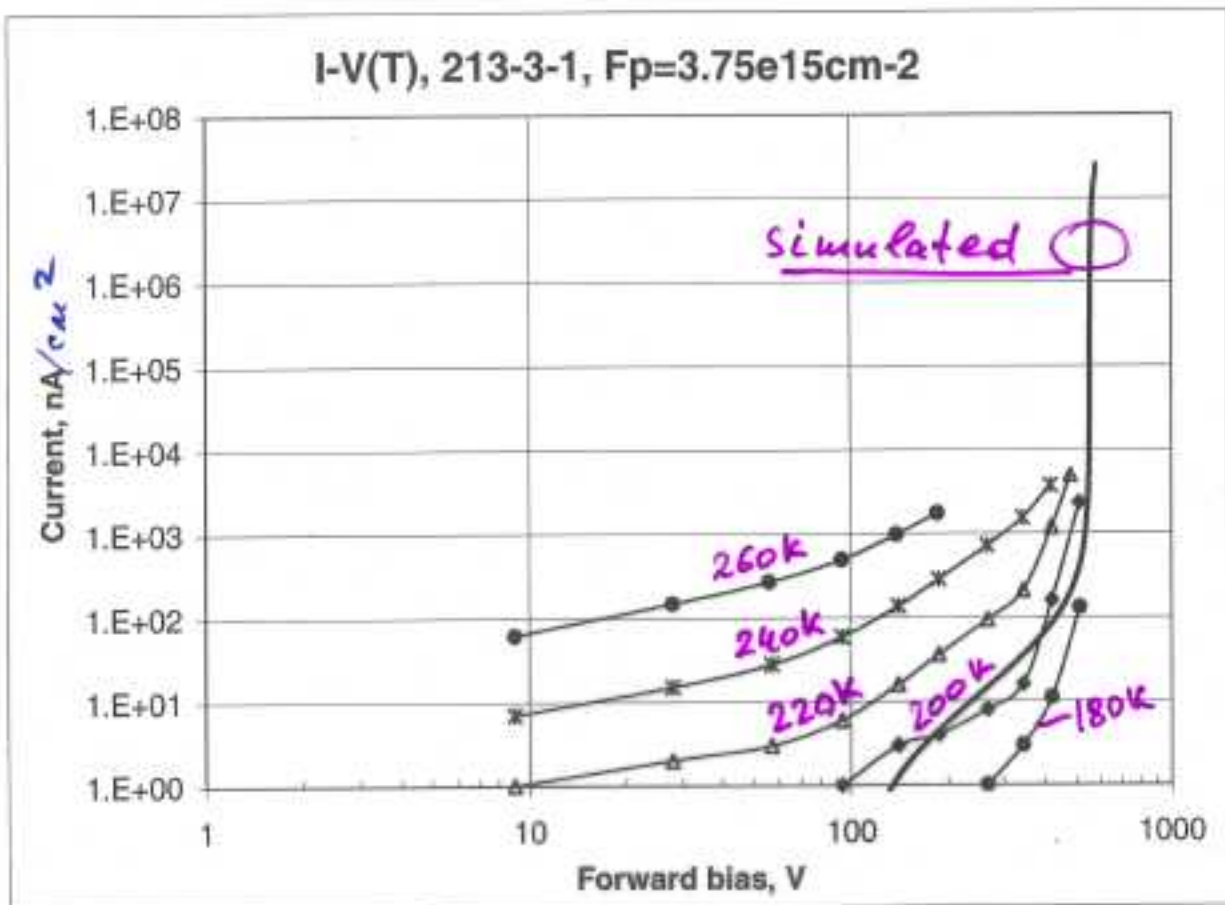
RT - C-V characteristics

p-n junction detectors



Forward I-V characteristics

- experiment
- simulation



Parameters for simulation:

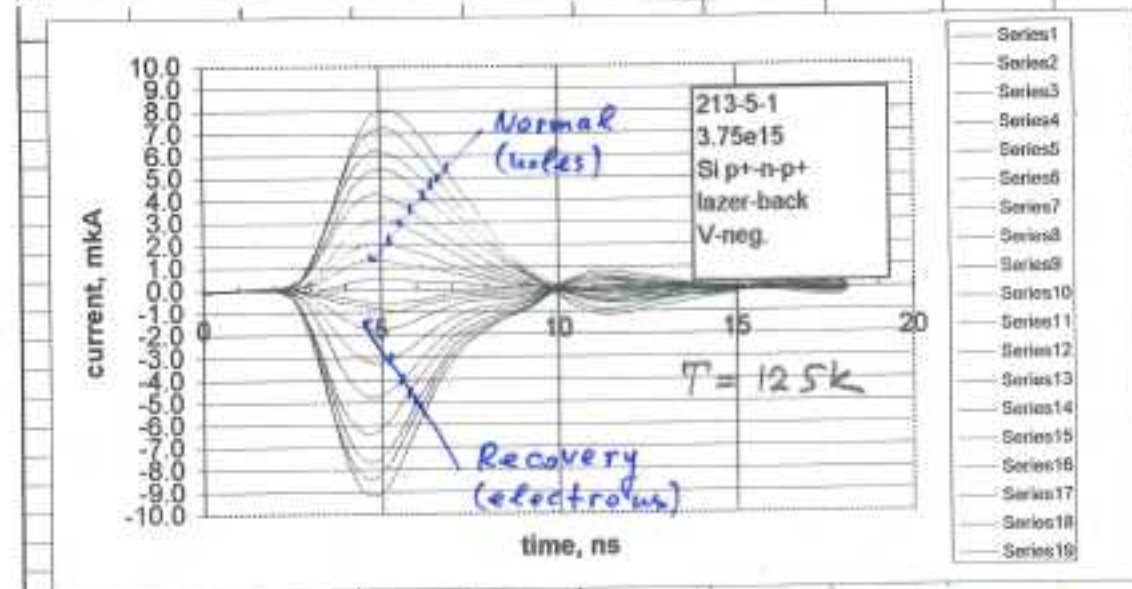
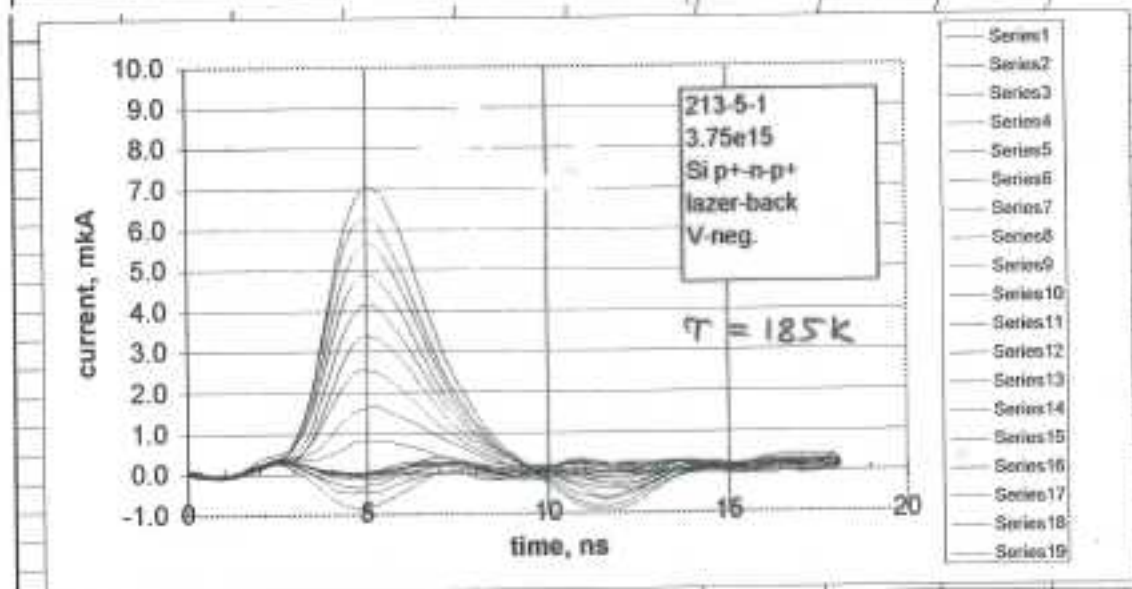
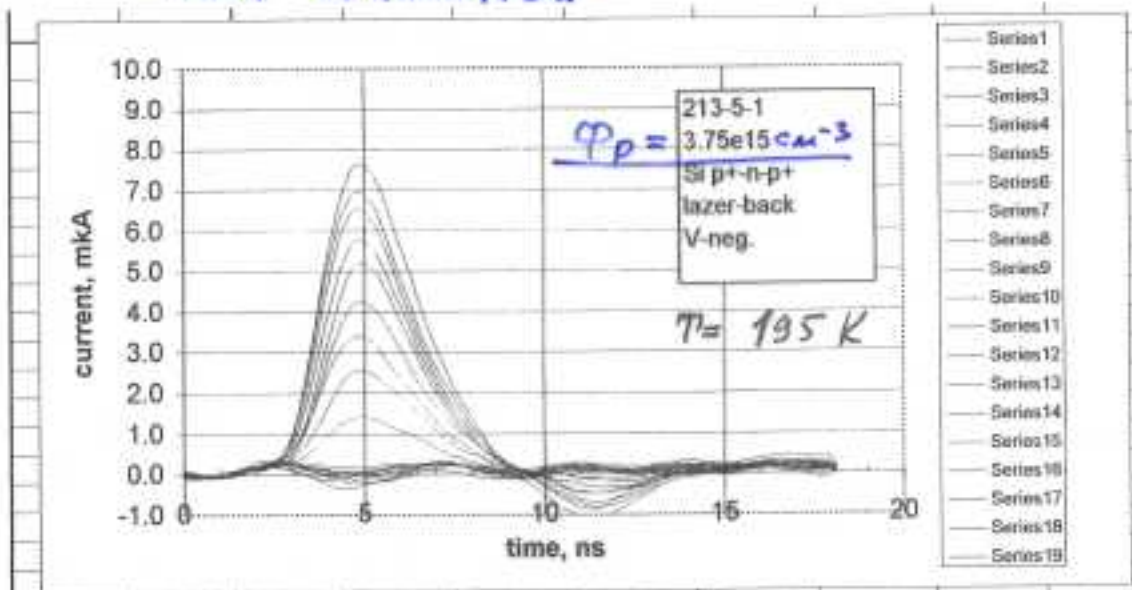
DL: donor, $G_n = G_p = 10^{-15} \text{ cm}^{-3}$, $E_v + 0.537 \text{ eV}$

$$N_{DL}^* = 4.5 \cdot 10^{12} \text{ cm}^{-3}$$

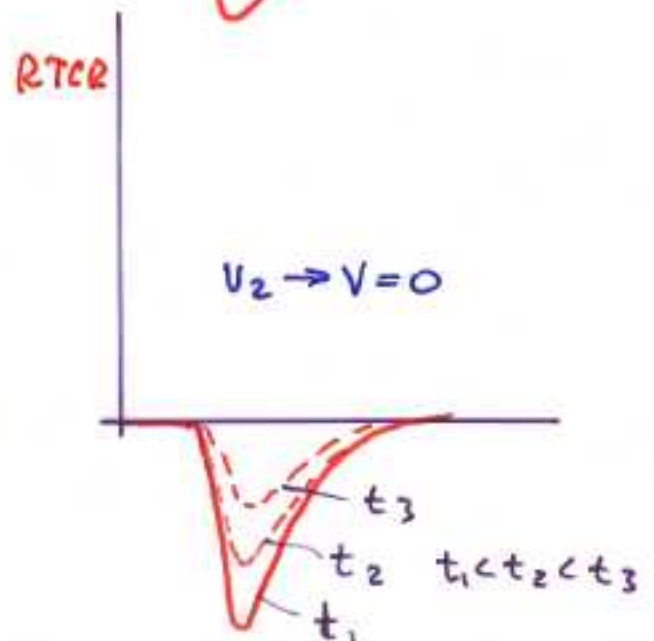
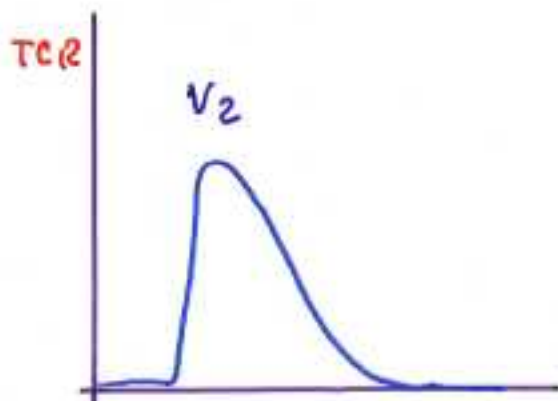
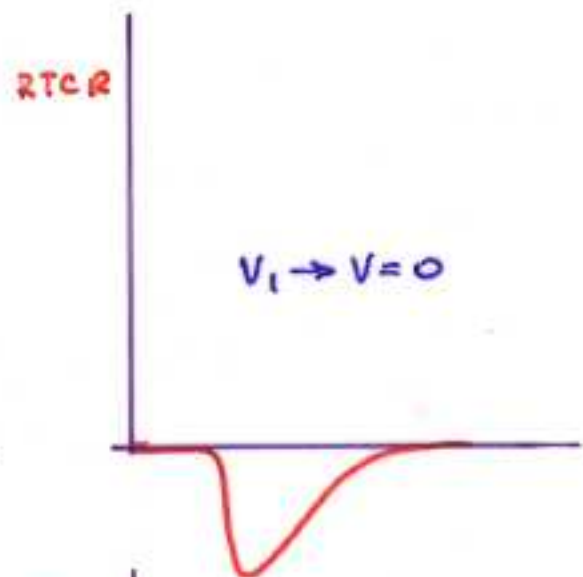
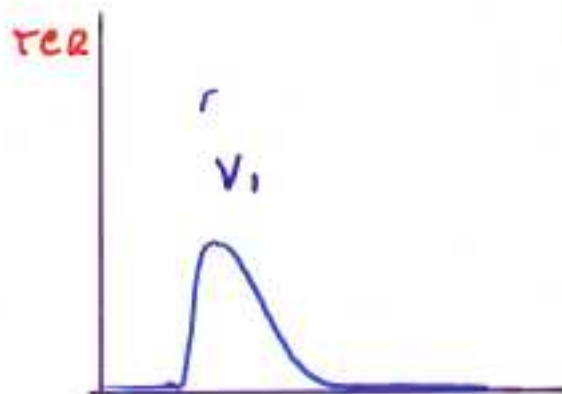
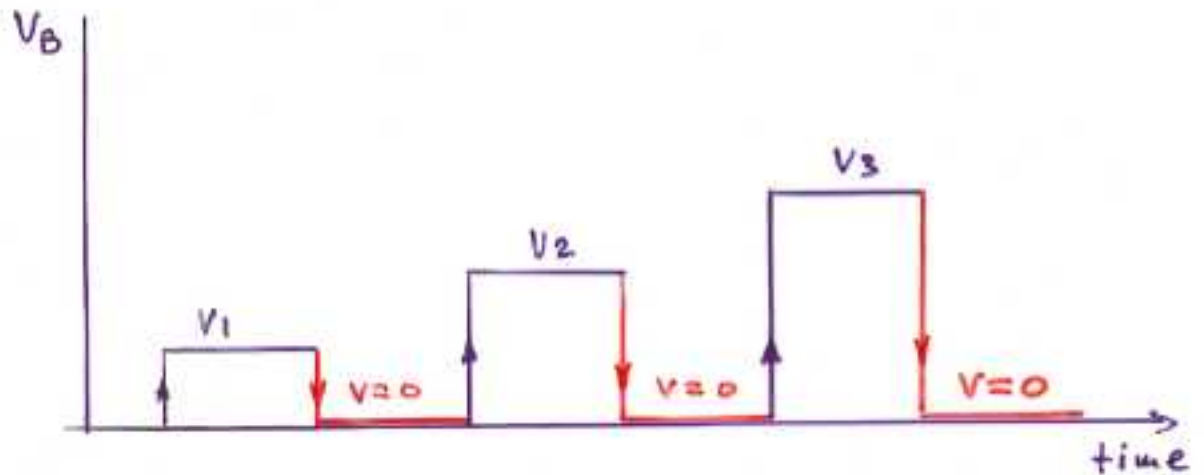
$$T = 200 \text{ K}$$

$$d = 400 \text{ nm}$$

Current response for p-n junction reverse biased detector hole collection

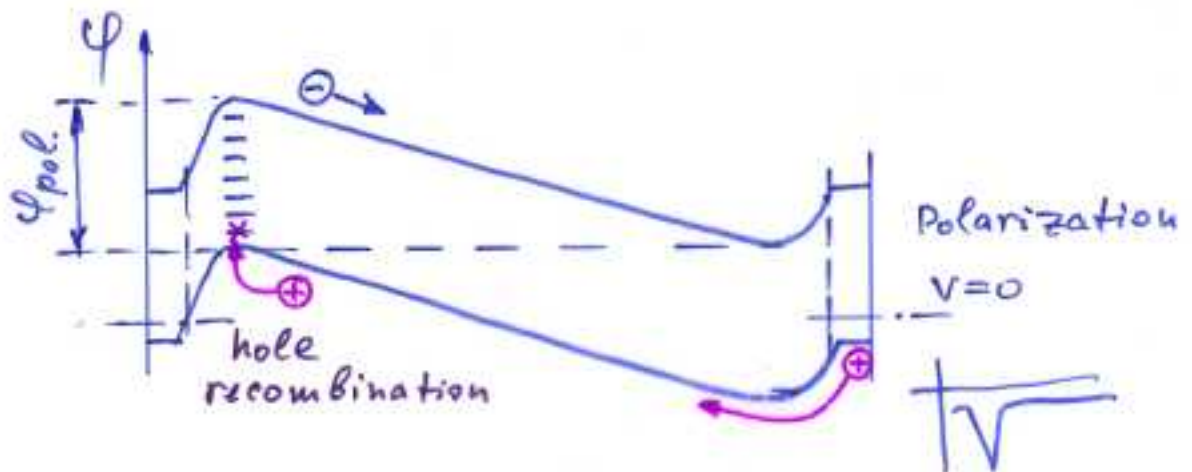
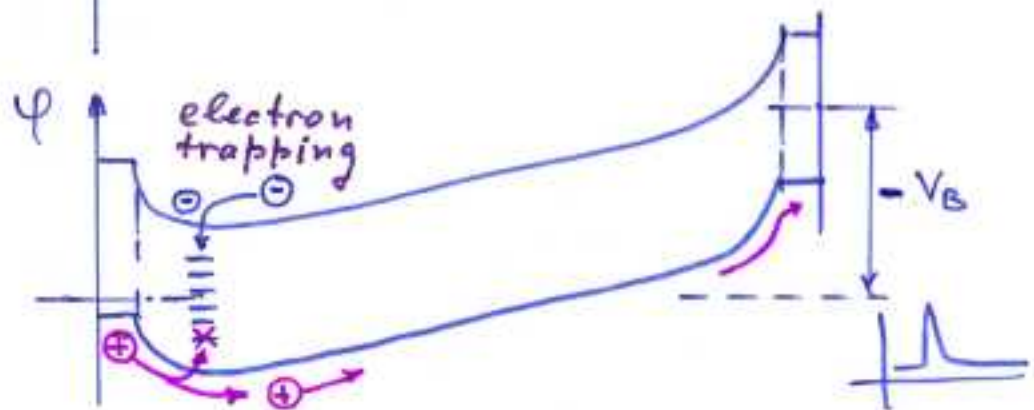
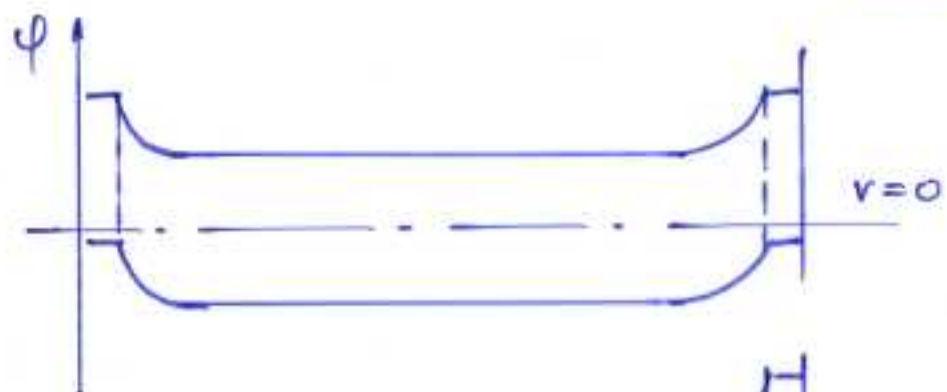
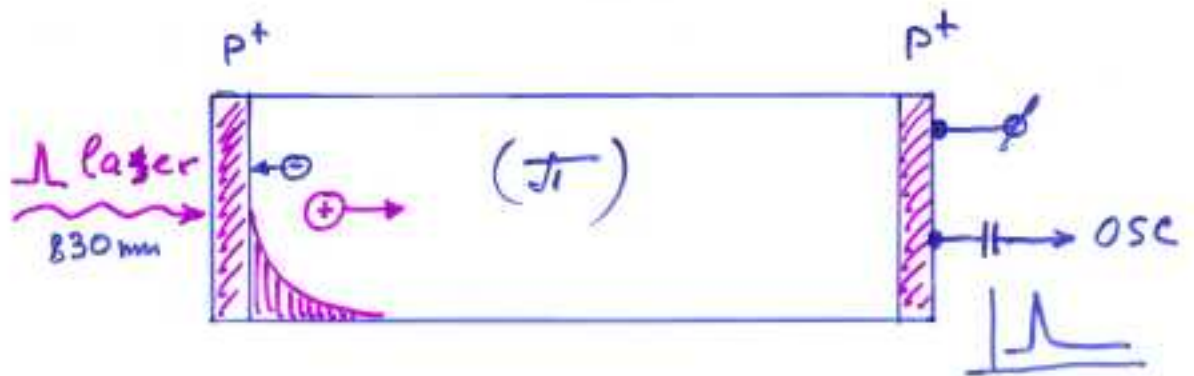


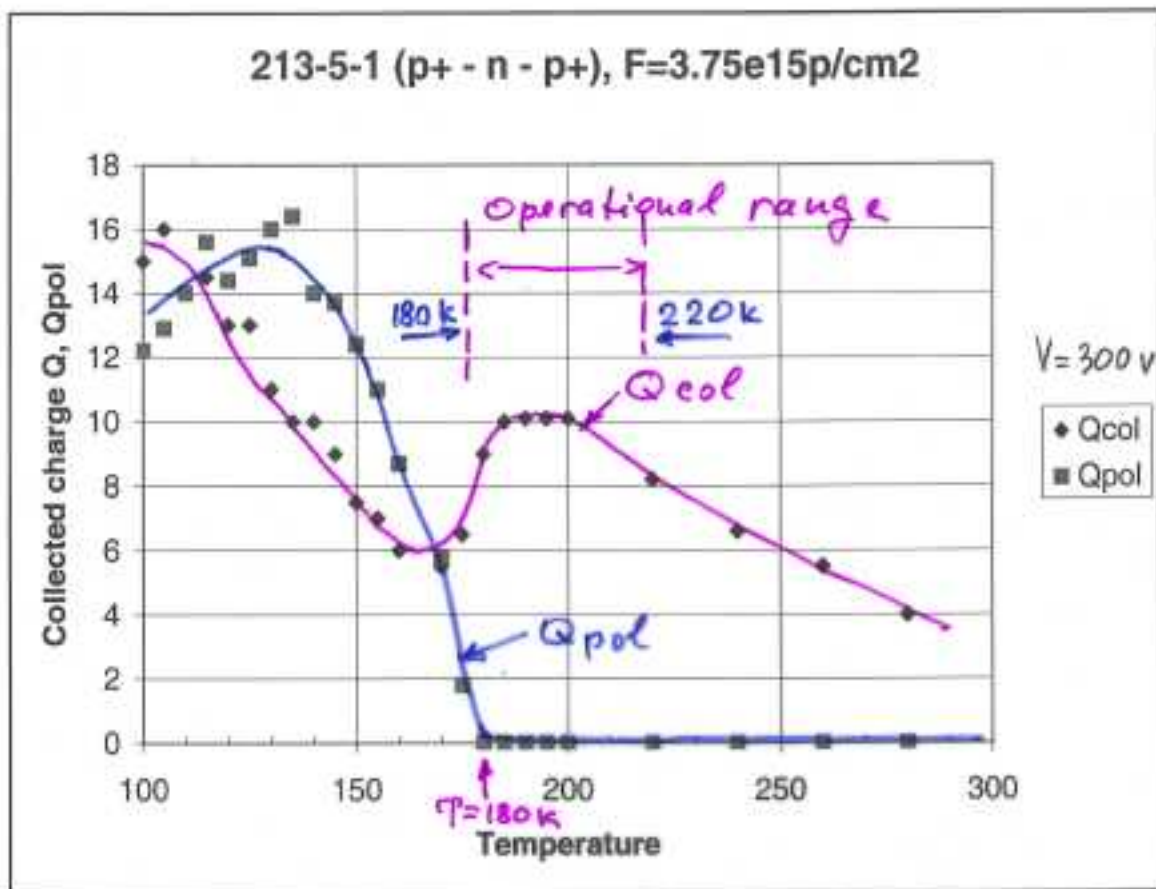
Transient Current Response (TCR) and Recovery Transient Current Response (RTCR)



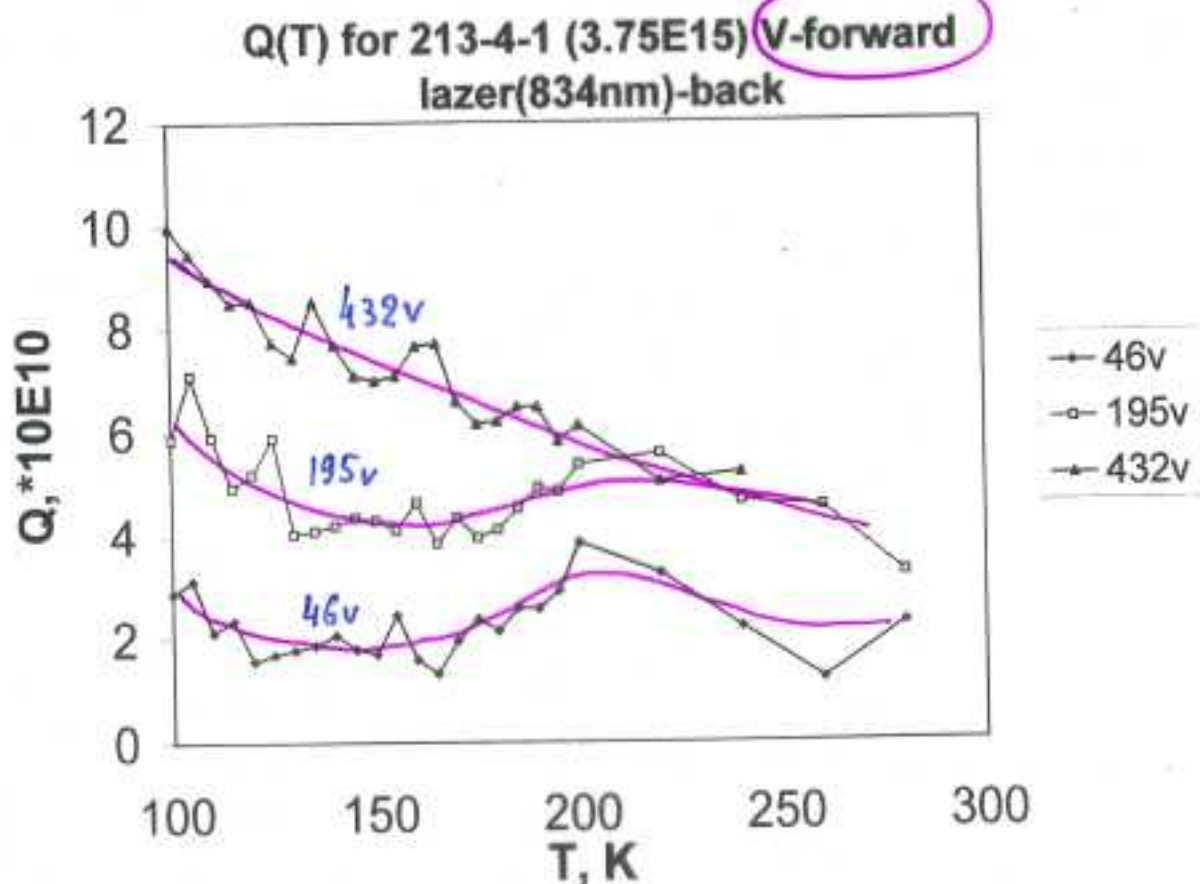
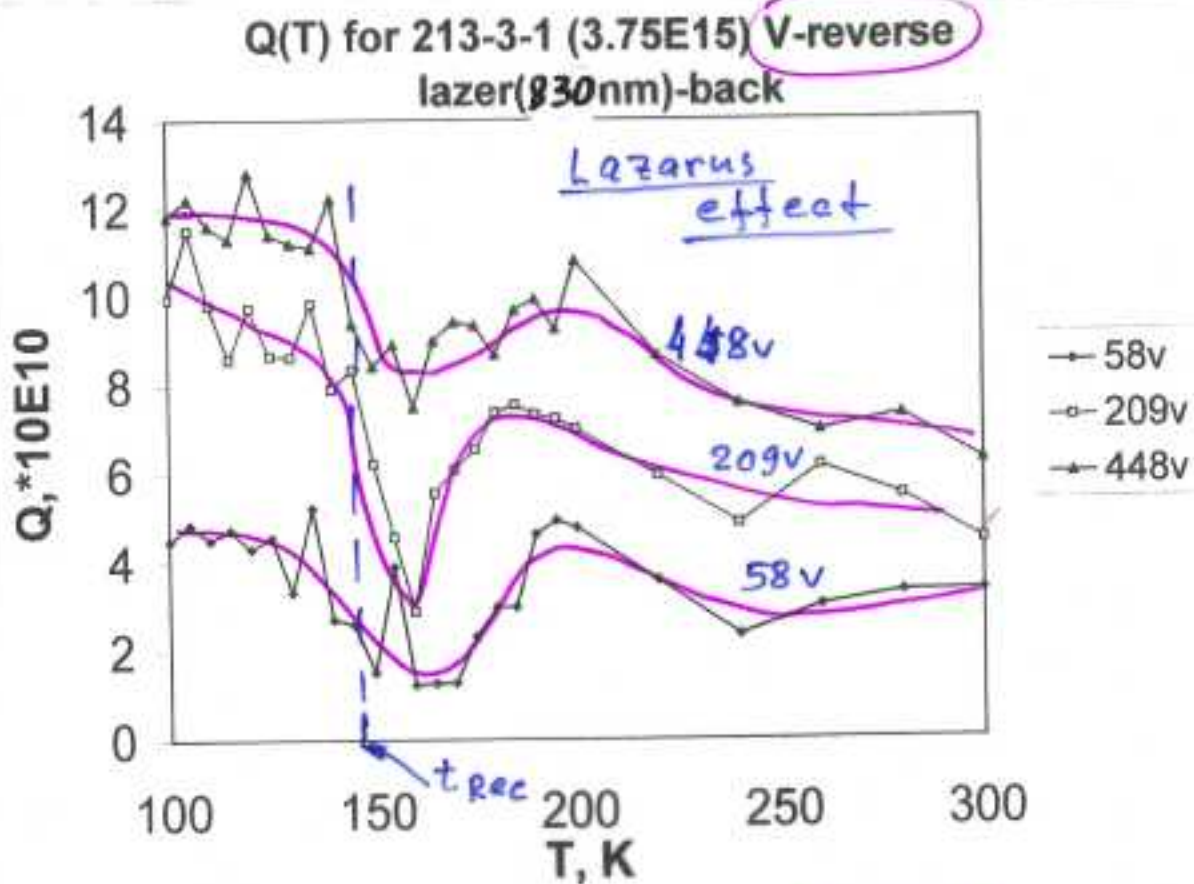
V. Brenin, RD 50, May 19.03

Polarization of p^+-n-p^+ detectors





Collected charge in p-n junction detectors



Conclusions

1. The simple model allows to define the major operational parameters of CID
 - V_{max}
 - $I_{operational}$
 - $E(x)$
2. The first observation of SCLC in silicon irradiated p-n junctions
3. The model gives a way to extract the value of non charged fraction of DL
4. The rest questions:
 - CCE for MIPS
 - Where is a double side injection??
5. The advantages of p^+-n-p^+ CID:
 - positive (regular) polarity of signal
 - compatibility with regular electronics
 - appropriate operational temperature range.